

an active ingredient member comprising a mold removing ingredient, said active ingredient member having a thickness of not more than 5 mm;

a liquid-permeable adhesive member having a thickness of not more than 5 mm comprising a hydrophilic adhesive and a polyol plasticizer; and

an isolating layer having a basis weight of 2 to 100 g/m<sup>2</sup> which separates said active ingredient member from said adhesive member but which permits migration of said mold removing ingredient to at least a portion of said adhesive upon use;

wherein said hydrophilic adhesive is at least 30% by weight of said liquid-permeable adhesive member, said hydrophilic adhesive has a water content of 0.1% to 60% by weight,

wherein said adhesive member substantially covers one side of said isolating layer, and

said cleaning assembly upon use being adhered to an object to be cleaned by applying the adhesive member to a mold-containing surface of the object whereby at least a portion of said adhesive contacts said mold and thereafter applying water thereto whereby said mold-removing ingredient passes through said adhesive to contact said mold.

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11. (Twice Amended) An adhesive mold removing cleaning assembly comprising:

- a) a liquid-permeable supporting sheet having a basis weight of 5 to 200 g/m<sup>2</sup>;
- b) an active ingredient-containing sheet comprising a mold removing ingredient;
- c) an adhesive layer having a thickness of not more than 5 mm comprising a hydrophilic adhesive and a polyol plasticizer; and
- d) an isolating layer which separates said active ingredient member from said adhesive member but which permits migration of said mold removing ingredient to at least a portion of said adhesive member upon use;

wherein said hydrophilic adhesive comprises at least 30% by weight of said liquid-permeable adhesive member c),

wherein said active ingredient-containing sheet b) is laminated to said isolating layer d), whereby the surface of said active ingredient-containing sheet b) is covered with said isolating layer d), with said adhesive member covering at least a portion of said isolating layer opposite of said active ingredient-containing sheet, and

at least a portion of said adhesive member of said adhesive mold removing cleaning assembly upon use being adhered to the surface of an object to be cleaned by contacting at least a

portion of said liquid-permeable adhesive layer c) thereof with a mold-containing surface of the object and thereafter applying water thereto whereby said mold-removing ingredient passes through said adhesive to contact said mold.

18. (Amended) An adhesive mold removing cleaning assembly comprising:

a liquid-permeable supporting sheet having a basis weight of 5 to 200 g/m<sup>2</sup>;

an adhesive layer having a thickness of not more than 5 mm comprising a hydrophilic adhesive and a polyol plasticizer;

said hydrophilic adhesive having admixed therewith a multitude of particles of a mold removing ingredient;

wherein said hydrophilic adhesive is at least 30% by weight of said adhesive layer and has a water content of 0.1% to 60% by weight;

the surface of each of said mold removing particles being coated with a water-soluble isolating layer to prevent contact between said mold removing particles and said hydrophilic adhesive; and

said cleaning assembly upon use being adhered to the surface of an object to be cleaned by applying the adhesive layer thereof to a mold-containing surface of the object whereby at least a portion of said adhesive contacts said mold and applying water

thereto whereby said mold removing ingredient passes through said adhesive to contact said mold.

Add the following new claims 26-29:

- - 26. The adhesive mold removing cleaning assembly of claim 11, wherein said adhesive member has a perforated structure having through-holes.

27. The adhesive mold removing cleaning assembly of claim 11, wherein said adhesive member comprises a plurality of spaced-apart adhesive bands.

28. The adhesive mold removing cleaning assembly of claim 18, wherein said adhesive member has a perforated structure having through-holes.

29. The adhesive mold removing cleaning assembly of claim 18, wherein said adhesive member comprises a plurality of spaced-apart adhesive bands. - -

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